NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE20P70G uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =-20V,I_D =-70A

 $R_{DS(ON)} < 3m\Omega$ @ V_{GS} =-4.5V

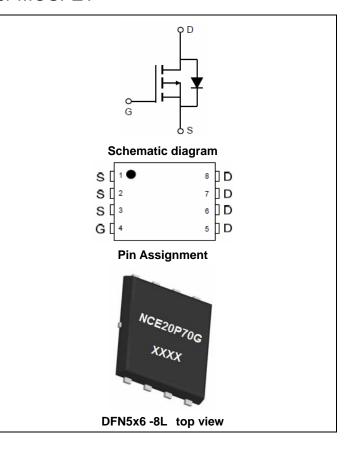
 $R_{DS(ON)} < 4m\Omega @ V_{GS} = -2.5V$

 $R_{DS(ON)}$ < 8m Ω @ V_{GS} =-1.8V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switch
- Battery protection



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE20P70G	NCE20P70G	DFN 5x6 -8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±10	V
Drain Current-Continuous	I _D	-70	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-49.5	Α
Pulsed Drain Current ^(Note 1)	I _{DM}	-280	Α
Maximum Power Dissipation	P _D	130	W
Derating factor		1.04	W/℃
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R ₀ JC	0.96	°C/W	1
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Electrical Characteristics (T_C=25 $^{\circ}$ C unless otherwise noted)

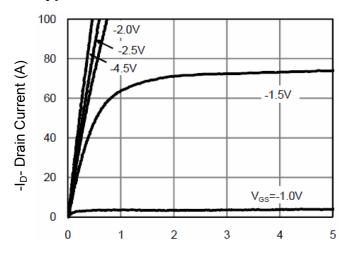
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-0.4	-0.6	-1.0	V
		V _{GS} =-4.5V, I _D =-20A	-	2.3	3	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-2.5V, I _D =-20A	-	2.8	4	
		V _{GS} =-1.8V, I _D =-20A		3.8	8	
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	100	-	-	S
Dynamic Characteristics (Note4)	•		•			
Input Capacitance	C _{lss}	V _{DS} =-10V,V _{GS} =0V,	-	4950	-	PF
Output Capacitance	Coss		-	380	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	290	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	t _r	V_{DD} =-10V, R_{GEN} =3 Ω	-	50	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-4.5V, R_L =0.5 Ω	-	100	-	nS
Turn-Off Fall Time	t _f		-	40	-	nS
Total Gate Charge	Qg	V - 40VI - 20A	-	100	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-10V, I_{D} =-20A, V_{GS} =-4.5V	-	21	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} 4.5V	-	32	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-70	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = -10A	-	48	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	55	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LI				y LS+LD)

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

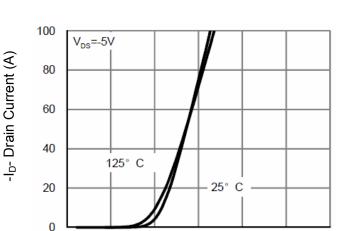


Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



-Vgs Gate-Source Voltage (V)

1.5

2

2.5

1

0

0.5

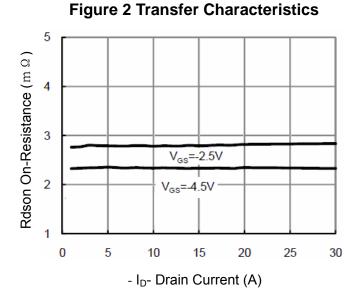


Figure 3 Rdson- Drain Current

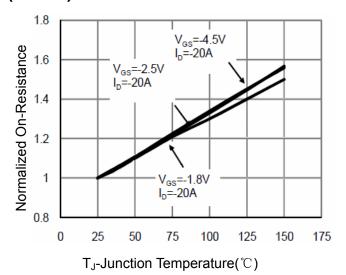


Figure 4 Rdson-Junction Temperature

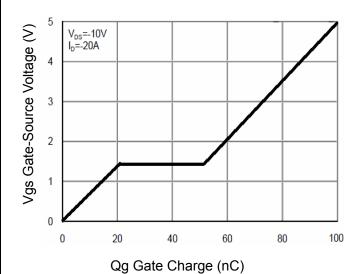


Figure 5 Gate Charge

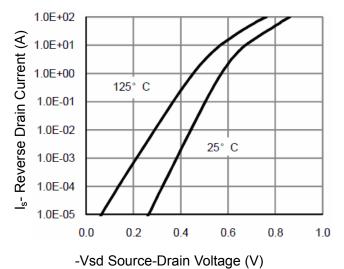


Figure 6 Source- Drain Diode Forward



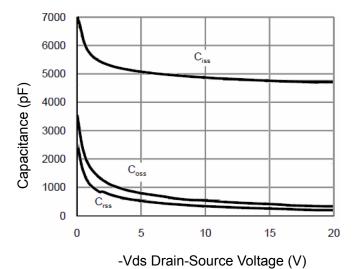
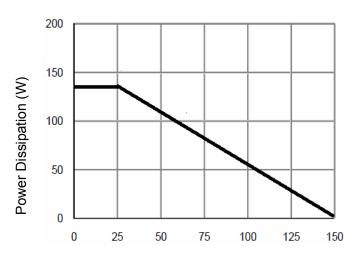


Figure 7 Capacitance vs Vds



 T_J -Junction Temperature($^{\circ}$ C) **Figure 9 Power De-rating**

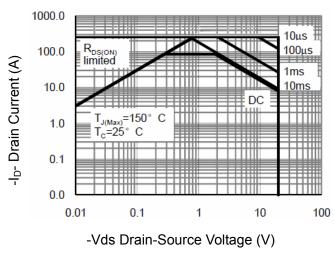


Figure 8 Safe Operation Area

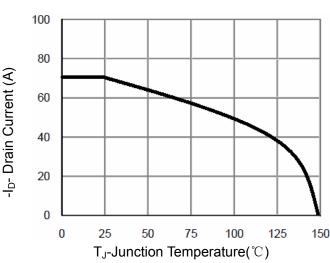


Figure 10 -Current De-rating

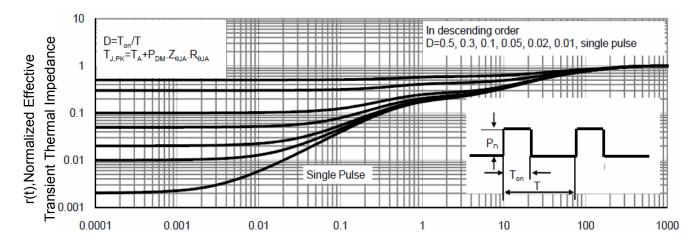
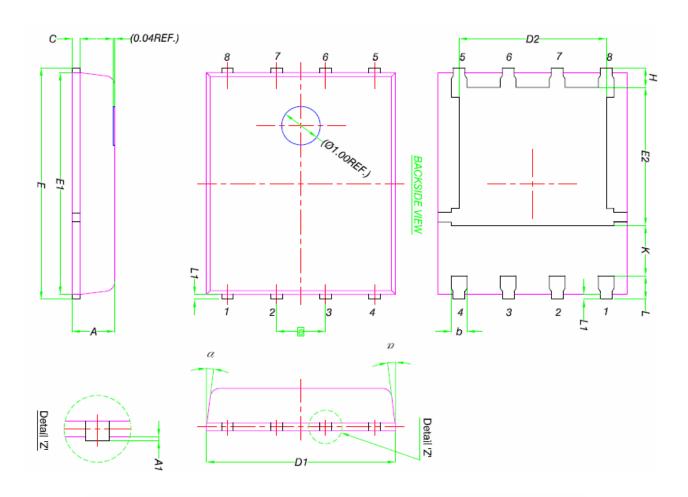


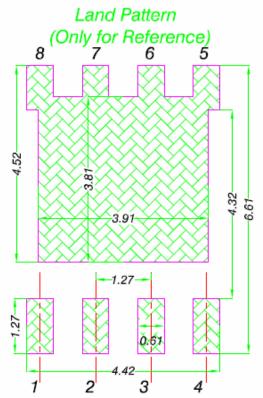
Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)

DFN5X6-8L Package Information



	I				
5/4	MILLIMETERS				
DIM.	MIN.	MIN. NOM.			
Α	0.90	1.00	1.10		
A1	0	-	0.05		
b	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е	1.27 BSC				
Н	0.41	0.51	0.61		
K	1.10	-	-		
L	0.51	0.61	0.71		
L1	0.06	0.13	0.20		
α	<i>0</i> °	-	12°		



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